

- Designed for GSM BTS Transmitter Applications
- Low Insertion Loss and Small Size
- 8.5 x 5.8 mm Surface-Mount Case
- Unbalanced Input and Output



Characteristic Nominal Center Frequency		Sym	Min	Тур	Max	Units	Notes		
		fc		286.000		MHz	1		
Passband	Insertion Loss at fc	IL		6	8.0	dB			
	3 dB Passband	BW ₃	±275			kHz	1, 2		
	Amplitude Ripple over fc \pm 75 kHz				0.3	dB _{P-P}			
	Group Delay Variation over fc \pm 75 kHz	GDV			100	NS _{P-P}			
Rejection	100 kHz to fc-6.0 MHz and fc+6.0 to 540 MHz		20	40		dB	1, 2, 3		
-	Ultimate			>40					
Operating Temperature Range		T _A	-40		+85	°C	1		
Impedance Matching to 50 Ω unbalanced			External L-C						
Case Style		SM8558-8 8.5 x 5.8 mm Nominal Footprint							
Lid Symbolization (YY=year, WW=week, XXX=lot code)		RFM SF1083B YYWWXXX							

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +85	°C
Max Soldering Profile	235°C for 90 s	

Electrical Connections

Connection	Terminals					
Port 1 Hot	7					
Port 1 Gnd Return	1					
Port 2 Hot	3					
Port 2 Gnd Return	5					
Case Ground	All Others					

Notes:

- 2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
- 4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- 5. The design, manufacturing process, and specifications of this filter are subject to change.
- 6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.

7. US and international patents may apply.

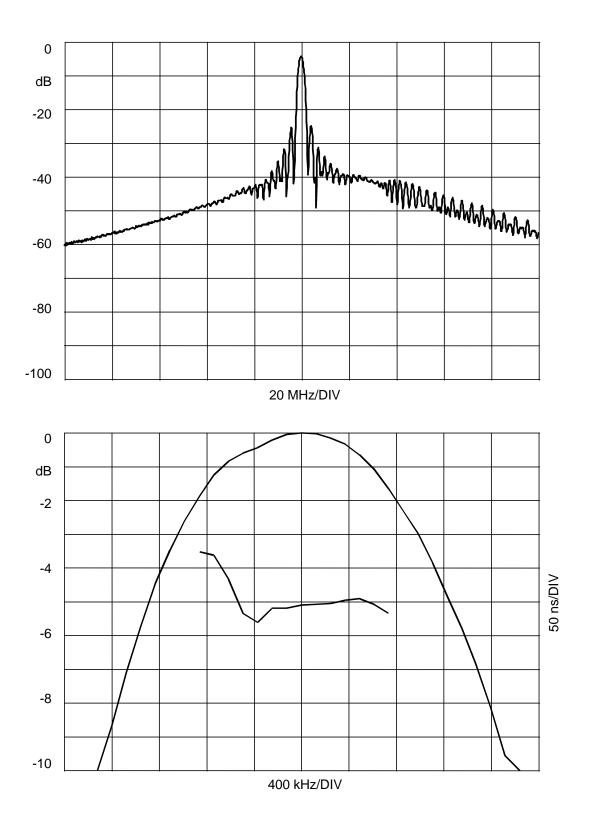
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- 10. Electrostatic Sensitive Device. Observe precautions for handling.



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^{1.} Unless noted otherwise, all specifications apply *over the operating temperature range* with filter soldered to the specified demonstration board with impedance matching to 50Ω and measured with 50Ω network analyzer.



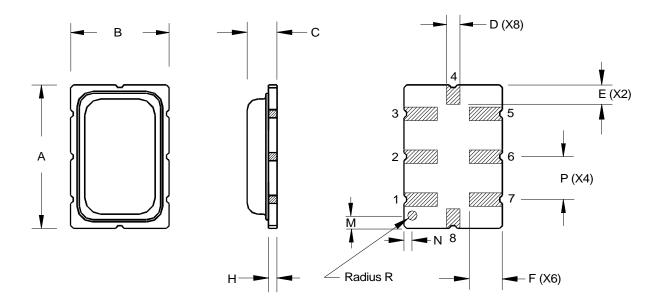
Phone: +1(972)233-2903 Fax: +1(972)387-8148 e-mail: <u>info@rfm.com</u> Home page: <u>www.rfm.com</u> **European Sales Office** 44 1963 251383 44 1963 251510



8-Terminal Ceramic Surface-Mount Case 8.5 x 5.8 mm Nominal Footprint

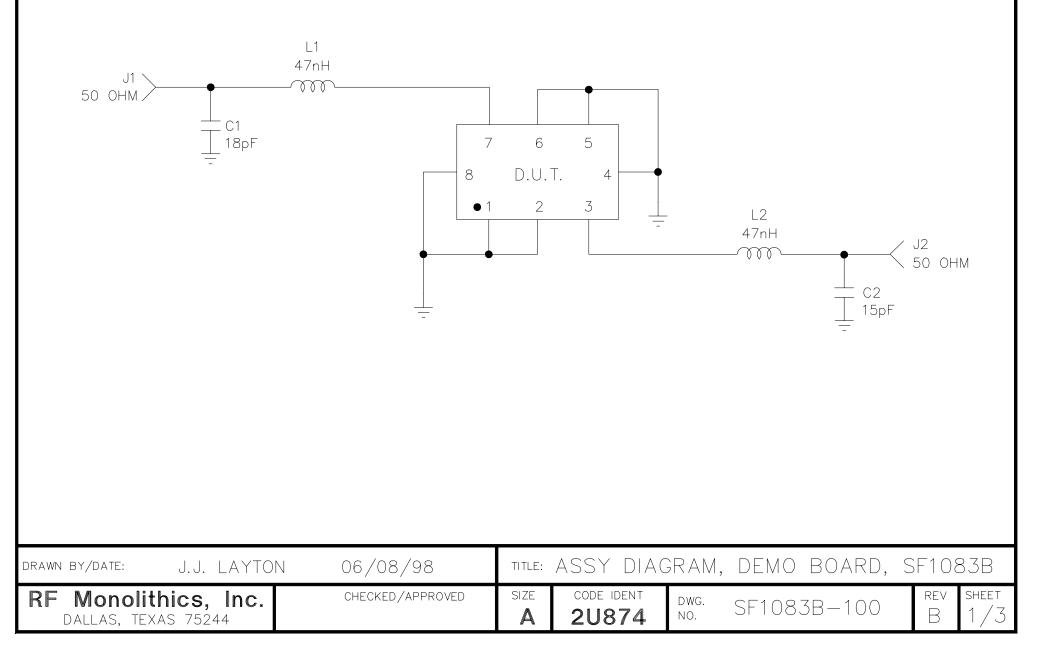


Dimension	mm			Inches			
Dimension	Min	Nom	Max	Min	Nom	Max	
A	8.26	8.51	8.76	0.325	0.335	0.345	
В	5.59	5.84	6.10	0.220	0.230	0.240	
С		1.70	2.00		0.067	0.079	
D		0.79			0.031		
E		1.14			0.045		
F		1.98			0.078		
Н		0.51			0.020		
М		0.76			0.030		
Ν		0.51			0.020		
Р		2.54			0.100		
R		0.51			0.020		



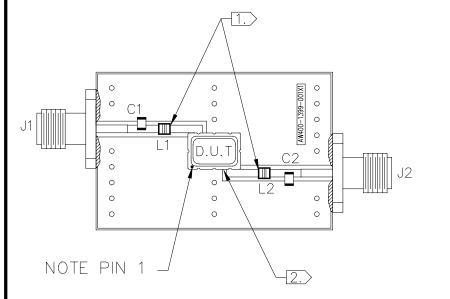
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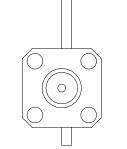
REV	EV ECN	ECN NO.	DESCRIPTION	DATE
A	A 677	6771	INITIAL RELEASE	6/8/98
В		7677	C2 WAS 18pf	5/4/99

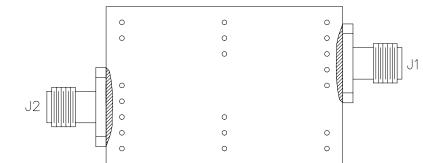


NOTES:

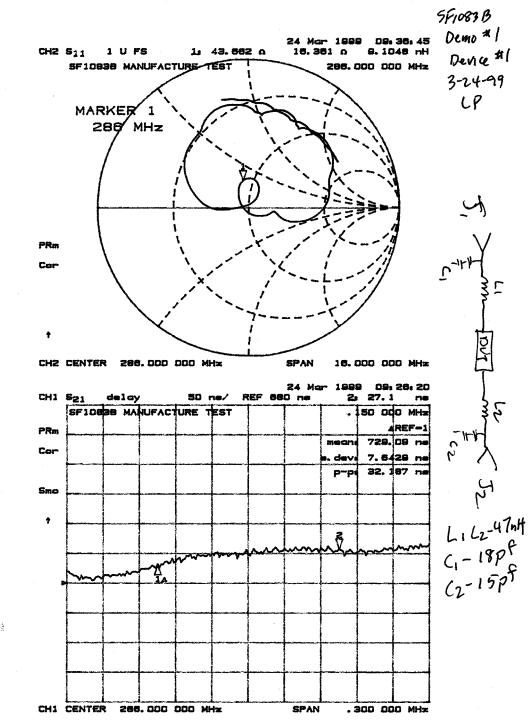
- 1. CUT TRACE (2 PLACES) ON PCB FOR L1 & L2.
- 2.> INSTALL DUT AS SHOWN.
- 3. INSTALL TUNING COMPONENTS.
- 4. INSTALL CONNECTORS. SOLDER BULKHEAD TO BOTH SIDES OF PCB.

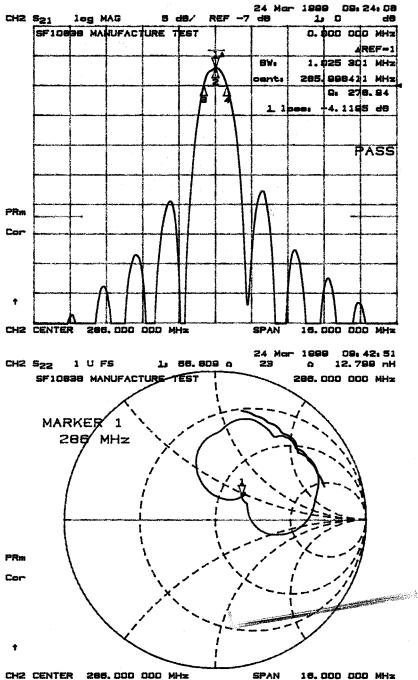






RF Monolithics, Inc.	S	SIZE	CODE IDENT	DWG. CF1007D 100		SHEET
DALLAS, TEXAS 75244		A	2U874	NO. SF1083B-100	В	2





CH2 CENTER 288.000 000 MHz